DP-1500-2X DP-1500-2XL

Dual-Sided Photoimageable Ink Coaters



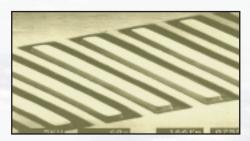
CIRCUIT AUTOMATION

Versatile • **Productive** • **Efficient**



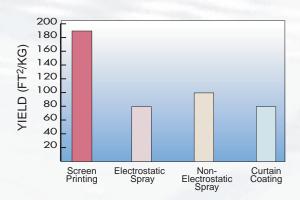
Versatility oft he Machine

Photoimageabled ielectric material, BGA panelsan dl iquid photoimageable resist material are coated on DP-1500's in production.



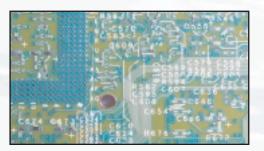
Fine Linean dF eature Capability

The uniforman d controllablet hickness of screen printed LPISMal lowst he imaging of very fine features. Soldermask can be coated ower than the feature height.



Efficiency

Screen printing is much more efficient han curtain coating or spray coating for a pplying mask. Int ypical use, screen printing can be expected to coatn early twice as much surface a rea as other processes, and thus cost half as much.



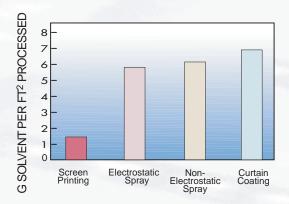
Photoimageable Legend Ink

Dual sided coating of photoimageable legendand marking inks will improve yields and reduce cyclet ime int his critical process.



Flatand Thick Coverage

BGA panels require at hick, consistent and flat surface and can be coated with one passt of hed esired thickness of soldermask.



Lower Solvent Emissions

Thel ower solvent content oft he ink actually applied reduces solvent emissions byt wot o fivet imes over other processes. This reduces, and may eliminate, additional air pollution control costs.

DP-1500-2X Dual-Sided Coater

TheDP-1500coatingmac hinesa rethei dealc hoice forco ating liquid photoimageablein kon printed circuit boards. DP-1500'sa pplya llt ypeso f liquid photoimageablecoating s, including soldermask, primary image, dielectric, and legend. TheDP-1500-2XLe xpandsth ema ximum panel size from 30" ontheDP-1500-2Xto co atah uge 36" x 24" backpanel. These versatilemac hinesin corporatemo rethaneight yearso fe xperienceo f dual-sidedco ating withman yne w features designed to reducec yeletime, increase yieldsan d improve process reliability.

DP-1500 Coating Applications

- Dual-sided coating of LPI soldermask
- Soldermask for BGA boards
- Photoimageable Legend
- Photo definable dielectric for built up multilayers
- Backpanels
- Thin substrates and flexible circuits

DP-1500'sa re fast: cycle time for loadingcoating and unloadingan1 8" x 24" panelca n bea s short as 22 seconds. High productivityi sma intained even whena varietyo f different sized jobsa re encountered duetothe



DP-1500's QC(Quick Change) TECHNOLOGY.

QC TECHNOLOGY allowsco mpletec hangeo ver of panel sizean din kt ypein lessth an10minutes. Thisi sac complished byth e unique design ofth e squeegeean din k reservoira ssembly.

Bothcan be swungo ut sothatthe screen

framesca n be removed witho ut disturbingthea lignmento fth e squeegeea ssembly. This provides complete access to the squeegees, flood bars, inkt roughs, and the print window on the screen so that the ymay be exchanged or cleaned readily. These productivity benefits a reonly found on Circuit Automatione quipment.

Qualityan d reproducibilityo fth ecoatinga reenhance d byth e unique screen printingtec hnique utilized by the DP-1500. Printingocc ursat hi gh squeegee pressurean d fast print speeds withhigho ff-contact but with a shallow squeegeeang leontight screenme sh. This te chnique en sures uniform coverage o veran d between

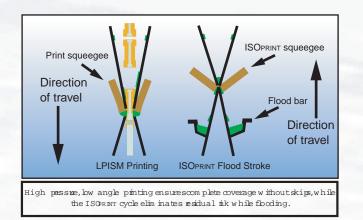


traces. Leadinge dge printing forcesth ein k
betweenan do vert races. Twoan dth reemi l lines
and spacesca n beenca psulated without skipso r
bubbles. Evenninemi lhi ght racesa recoate d reliably. BGA boards requirethic k, consistent, and
repeatablecoating s. DP-1500sco nsistently produce
boardsto me etthee ver-changing parametersin
coating requirements.

Advantages of Simultaneous Dual-Sided Coating

- Elimination of side–to–side variation
- Variety of coatings applied on one machine
- Controllable coating thickness
- Elimination of handling defects
- Multiskewable push stroke printing eliminates skips and ensures coverage of traces

The DP-1500 incorpor ates severalne w features as standarde quipment to enh ance the finished co ating quality. **ISO**PRINT is a system to remove their k that remains on the back of the screen, for example o verholes or



slots afterpr inting. **ISO**PRINTING forces ther esidual ink back to the front sideo f the screen mesh, where iti sin corporatedin to thene xt flood stroke. There areno w three different floodc hoices available to maximize thepo tentialo f different soldermasks. The latestpr ocessin novation, **No Flood**, has been proven to dramatically educe the amounto fin k thati sco atedin toco mponentho les. The servoco ntrolledpo sitioning system allows the machine to reposition thep anel betweenco atingc ycles (jog), ande ven tor eposition thep anel betweenpr int strokes (shuffle).

The DP-1500 's are designed to meet the specifications and expectations of highproduction manufacturing. Critical components have been up-sized toprovide vibration-free operation and longop erating life with a minimum of downtime. Maintenance per sonnel will appreciate the simplicity and e legance of the design,

 $making r\ out in e\ maintenance\ fast\ and\ straightforward.$

TheDP-1500i s simple tooper ate, clean, and maintain. The coatingc hamberi si solated from theoper ator and aco mprehensive safetyin terlock systemi spr ovided. The machines are constructed to meet the European Committee for Standardization and arry the CE mark.

The versatility of the DP-1500i sen hanced by its proven and reliable panel transport system. Panels are pinned in place and

hungin theco ater. Duringco ating, thep aneli s tensioned so thate ven thinp anels arehe ldr igidly. The tensioning straightens warpedp anels as well. This allows for ane ven application of soldermaskon all types of panels.

DP-1500-2X/2XL Dual-Sided Photoimageable Coaters

Panel Dimensions

Minimumsize	8" x 12"	203 x 305mm
Maximumsize		
DP-1500-2X	24" x 30"	610 x 762mm
DP-1500-2XL	24" x 36"	610 x 914mm
Minimum thickness	0.010"	0.25mm
Maximum thickness*	0.250"	6.4mm
*Ontional fixtures available to a	commodata nanalsii i	to 0.400"

Coating Features

CoatingM odes Flood and print Flood, print, print

Flood, print, flood, print, print

Flood only Fullym anual **No Flood Printing**

Reverse home position flooding

Print Speed 1.0 to 10in /sec 2.5 - 25 cm/sec

Flood Speed 1.0 to 10in /sec 2.5 - 25 cm/sec

Skew Squeegeem ay bes kewed ors traight

skewis reversible on alternates trokes

Aluminum; stretch and glue or Frame Type

self-tensioning frames

Frame Size

DP-1500-2X 37" x 46.6" 940 x 1184mm DP-1500-2XL 37" x 53.6" 940 x 1361mm

Servo Positioning Provides for precise panel positioning

> Allows jogging of a panel between prints Permitss huffle of panel between print

strokes

Shipping

Net weight	2500 lbs	1136 kilos
Gross weight	3000 lbs	1364 kilos
Crated Dimensions		
L	106"	2692mm
W	46"	1168 mm
Н	92"	2337mm

Productivity

Pane	lsi ze	Flood/Print	Flood/Print/Print
12"	305mm	20se c	25se c
18"	454mm	22se c	27se c
24"	610mm	24se c	29se c
30"	762mm	26se c	31se c
36"	914mm *	28se c	33se c

Cycle timeis time to load, coat, and un load a panel with LPI soldermask. "Panelsi ze" is the dimensionin the direction of coating. Differentin ks can require different print and flood speeds for optimal results.

*(DP-1500-2XL only)

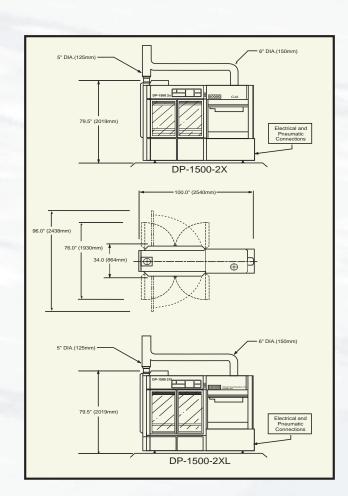
Utility Requirements

110 V 1 , 15 Amp **Electrical** 220 V 1 , 10 Amp

Pneumatic 3 cfm @ 100 psig 5m 3/hr @ 7 bar

Exhaust 250 cfm 425m 3/hr

Blowern otsu pplied



Thisin formationis believed to be true and accurate based on our laboratory testing ande xperience. Since actualus eis beyond our control, no warranties, express orim plied, exist. Specifications and design aresu bject to change withoutn otice.

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CIRCUIT AUTOMATION

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DP-1500-2XL Extra Large Panel LPI Coater



With the addition of the DP-1500-2XL model, ane ven a wider range ofp anel thicknesses and sizes can be coated. The DP-1500-2XL is designed to coat backpanels up to 24" x 36" in size and as thick as 0.400". The unique coating technique of the DP-1500 allows very high traces to be covered with soldermask. Nine mil traces can be covered with adequate thickness on the knee of the trace.

Coverage of High Traces

Screenp rintingp rovides precise metering of the ink deposit over circuitry, and screenp rinting inks have the highest viscosity and lowest solvent content. Thisp rovides uniform coverage one ven the highest traces. The unique printingp rocess utilized by the DP-1500 forces the ink between spaces and creates skip freep rinting.



Coating Thickness and Fill

Thickness of ink deposited will vary with the type of ink, circuit height, and the screen mesh used. Typical thickness over 3.0 mil trace is 0.6 mil using 110 tpi mesh, 1.0 mil using 86 tpi mesh, and 1.5 mil using 74 tpi mesh. 2.0 mil lines and spaces may be coated without skips or airen capsulation. 2 mil dams are producible because of the precise metering of ink.